DRAWING MADE IN THIRD ANGLE PROJECTION

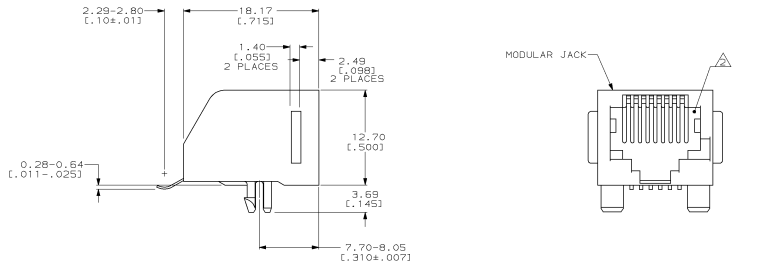
THIS DRAWING IS UNPUBLISHED. RELEASED FOR PUBLICATION ,19 .

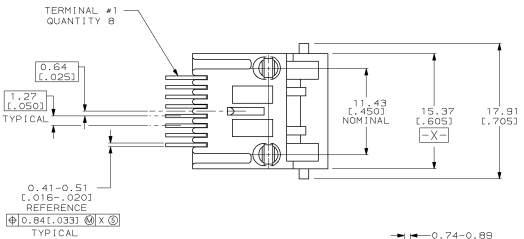
© COPYRIGHT 19 BY AMP INCORPORATED. ALL INTERNATIONAL RIGHTS RESERVED.

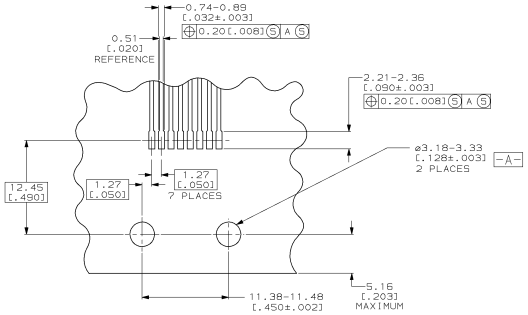
LOC	DIST
AA	22

REVISIONS

P	F	ZONE	LTR	DESCRIPTION	DATE	APPD
			P	REV; EC 0502-0711-97	23OCT97	RS







RECOMMENDED PRINTED CIRCUIT BOARD LAYOUT

1. MATERIAL: HOUSING - HTN MOLDING COMPOUND, 94 V0, BLACK.
   TERMINAL - 0.36 [.014] THICK PHOS-BRONZE PLATE WITH 1.27µm [.000050] THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 3.81µm [.000150] THICK TIN-LEAD IN SOLDER AREA OVER 1.27µm [.000050] THICK NICKEL UNDERPLATE.

2. CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68, SUBPART F.

3. ALL DIMENSIONS SHOWN ARE MAXIMUM UNLESS OTHERWISE SPECIFIED AND ARE PRIOR TO SURFACE MOUNT PROCESSING.

4. SNAP-IN RETENTION FEATURE ACCOMMODATES 1.45-1.70 [.062±.005] THICK PRINTED CIRCUIT BOARD.

NUMBER OF TERMINALS	PART NO
8	555078-1

DO NOT SCALE PRINT.
UNLESS SPECIFIED DIMENSIONS IN mm [INCHES]
TOLERANCES ON :
2 PLC DEC ± -
3 PLC DEC ± -
ANGLES ± -
MATERIAL
FINISH

DR	9-28-95 D. STRAUSSER
CHK	10-17-95 N. JONES
APPD	10-23-95 J. TONEY
APPD	10-24-95 M. MCGRATH
PRODUCT SPEC	108-1163
APPLICATION SPEC	114-6040
WEIGHT	-

AMP Incorporated
Harrisburg, PA 17105-3608

NAME
MODULAR JACK ASSEMBLY, 8 POSITION, LOW PROFILE, RIGHT ANGLE, SURFACE MOUNT, KEYED, WITH PANEL STOPS

SIZE	CAGE CODE	DRAWING NO
D	00779	C-555078

SCALE 4:1 SHEET 1 OF 1

THIS DRAWING IS A CONTROLLED DOCUMENT FOR AMP INCORPORATED. IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.

CUSTOMER DRAWING

AMP 1766-3 REV 3-92

23-OCT-97 11:12:12 amp33741 /home/amp33741/edmmod

W45 87-1244-2-1 & -2

Downloaded from Elcodis.com electronic components distributor